

## WG40N120MFW1

Rev.01 - 19 June 2024

**IGBT** 

#### **Product data sheet**

### 1. General description

WG40N120MFW1 uses advanced Fine Trench Field-stop IGBT technology with anti-parallel diode in TO-247 package. This device is part of the Medium speed series of IGBTs, which represents an optimum compromise between conduction and switching losses to maximize the efficiency of high switching frequency converter.



### 2. Features and benefits

- Maximum junction temperature 175 °C
- Medium switching speed
- · Positive Temperature efficient for Easy Parallel Operating
- Very soft, fast recovery anti-parallel diode
- EMI Improved Design

### 3. Applications

- Solar inverter
- UPS
- Welding converters
- PFC
- Mid to high switching frequency applications

### 4. Quick reference data

#### Table 1. Quick reference data

Symbol	Parameter		Notes	Value		Unit	
$V_{\text{CE}}$	Collector-emitter voltage, $T_j \ge 25 \text{ °C}$				1200		V
I <sub>C</sub>	DC collector current, limited by $T_{j(max)}$ T <sub>c</sub> = 100 °C				40		A
Symbol	Parameter Conditions		Notes	Min	Тур	Max	Unit
Static cha	racteristics	·					
$V_{\text{CE(sat)}}$	Collector-emitter saturation voltage	V <sub>GE</sub> = 15 V; I <sub>C</sub> = 40 A; T <sub>j</sub> = 25 °C		-	1.68	2.5	V

### 5. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		۹C
2	С	collector		
3	E	emitter		
mb	C	mounting base; connected to collector		G E sym200

### 6. Ordering information

Table 3. Ordering in	formation					
Type number	Package Name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date
WG40N120MFW1	TO247	WG40N120MFW1Q	Tube	30	SOT429	25-Mar-2013

### 7. Marking

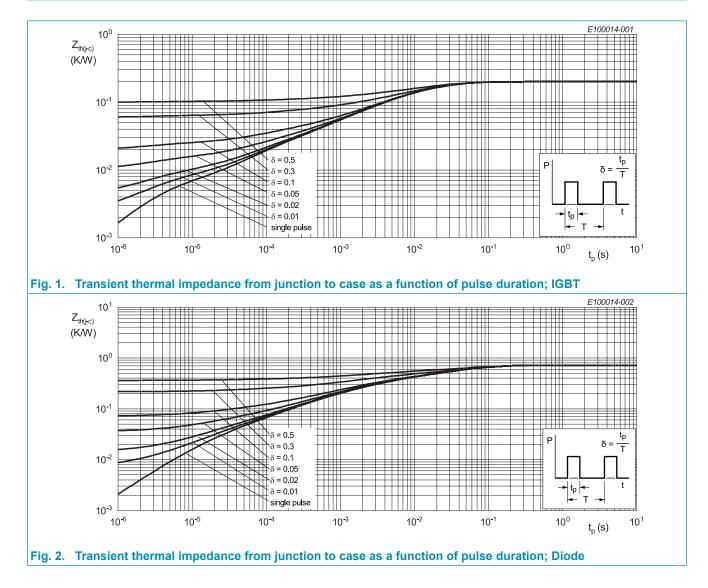
Table 4. Marking codes	
Type number	Marking codes
WG40N120MFW1	G40N120 MFW1

### 8. Limiting values

Symbol	Parameter	Notes	Value	Unit
V <sub>CE</sub>	Collector-emitter voltage, $T_j \ge 25 \text{ °C}$		1200	V
I <sub>C</sub>	DC collector current, limited by $T_{j(max)}$ T <sub>c</sub> = 25 °C T <sub>c</sub> = 100 °C		80 40	А
I <sub>C(puls)</sub>	Pulsed collector current, $t_p$ limited by $T_{j(max)}$		120	А
-	Turn off safe operating area V <sub>CE</sub> $\leq$ 1200 V, T <sub>j</sub> $\leq$ 175 °C, t <sub>p</sub> = 1 µs		120	A
I <sub>F</sub>	Diode forward current, limited by $T_{j(max)}$ T <sub>c</sub> = 25 °C T <sub>c</sub> = 100 °C		80 40	A
I <sub>Fpuls</sub>	Diode pulsed current, $t_p$ limited by $T_{j(max)}$		120	А
$V_{\text{GE}}$	Gate-emitter voltage		±20	V
P <sub>tot</sub>	Power dissipation $T_c = 25 \degree C$ Power dissipation $T_c = 100 \degree C$		750 375	W
t <sub>sc</sub>	Short circuit withstand time $V_{GE} = 15.0 \text{ V}, V_{CC} \le 600 \text{ V}$ Allowed number of short circuits < 1000 Time between short circuits: $\ge 1.0 \text{ s}$ $T_j = 175^{\circ}\text{C}$		10	us
T <sub>stg</sub>	Storage temperature		-55 to +150	°C
T <sub>jmax</sub>	Operating junction temperature		175	°C
-	Peak soldering temperture		260	°C
М	Mounting Torque with washer		0.55	Nm

### 9. Thermal characteristics

Table 6. Th	ermal characteristics						
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
R <sub>th(j-c)</sub>	IGBT thermal resistance from junction to case			-	0.20	-	K/W
R <sub>th(j-c)</sub>	Diode thermal resistance from junction to case			-	0.72	-	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient			-	40	-	K/W



### **10. Characteristics**

Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static cha	aracteristics				•		
$BV_{CES}$	Collector-emitter breakdown voltage	$V_{GE} = 0 V; I_{C} = 1 mA$		1200	-	-	V
V <sub>CE(sat)</sub>	Collector-emitter saturation	$V_{GE}$ = 15 V; I <sub>C</sub> = 40 A; T <sub>j</sub> = 25 °C		-	1.68	2.5	V
	voltage	V <sub>GE</sub> = 15 V; I <sub>C</sub> = 40 A; T <sub>j</sub> = 175 °C		-	2.2	-	V
V <sub>F</sub> Diode forward voltage	Diode forward voltage	$V_{GE}$ = 0 V; I <sub>F</sub> = 40 A; T <sub>j</sub> = 25 °C		-	2.3	-	V
		V <sub>GE</sub> = 0 V; I <sub>F</sub> = 40 A; T <sub>j</sub> = 175 °C		-	2.1	-	V
$V_{\text{GE(th)}}$	Gate-emitter threhold voltage	$I_{c}$ = 0.5 mA; $V_{ce}$ = $V_{ge}$		4.2	5.3	6.4	V
I <sub>CES</sub>	Zero gate voltage collector	$V_{CE}$ = 1200 V; $V_{GE}$ = 0 V; $T_{j}$ = 25 °C		-	-	250	μA
	current	V <sub>CE</sub> =1200 V;V <sub>GE</sub> = 0 V; T <sub>j</sub> = 175 °C		-	-	10	mA
<b>g</b> <sub>fs</sub>	Transconductance	$V_{ce}$ = 20 V; I <sub>c</sub> = 40 A		-	22	-	S
Dynamic	characteristics						
C <sub>ies</sub>	Input capacitance	$V_{CE}$ = 30 V; $V_{GE}$ = 0 V; f = 1 MHz;		-	6662	-	pF
C <sub>oes</sub>	Output capacitance	T <sub>j</sub> = 25 °C		-	137	-	pF
C <sub>res</sub>	Reverse transfer capacitance			-	25	-	pF
Q <sub>G</sub>	Gate charge	V <sub>CC</sub> = 960 V; I <sub>C</sub> = 40 A; V <sub>GE</sub> = 15 V; T <sub>i</sub> = 25 °C		-	200	-	nC

Unit

nS nS nS nS mJ mJ mJ nS nS nS nS mJ mJ mJ

nS nC А

nS nC

А

-

26

-

#### 1 \_

Reverse recovery peak

current

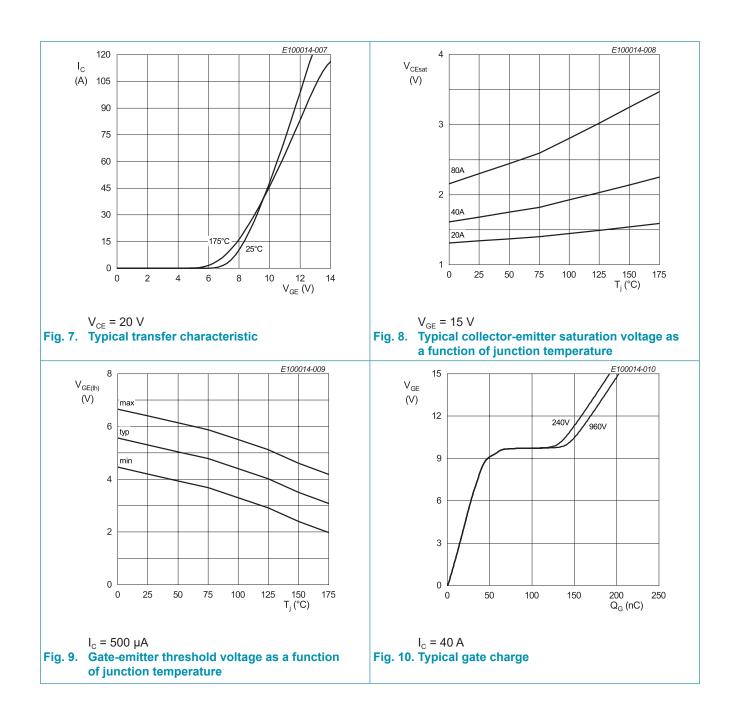
Table 8. S	witching Characteristics, Ir	nductive Load				
Symbol	Parameter	Conditions	Notes	Min	Тур	Max
IGBT cha	racteristics					
$\mathbf{t}_{d(on)}$	Turn-on delay time	$T_j = 25$ °C; $V_{CC} = 600$ V; I <sub>C</sub> = 40 A; V <sub>GE</sub> = 15V / 0V; $R_G = 10 $ Ω		-	60	-
t <sub>r</sub>	Rise time			-	46	-
$t_{d(off)}$	Turn-off delay time			-	254	-
t <sub>f</sub>	Fall time			-	101	-
Eon	Turn-on energy			-	2.5	-
E <sub>off</sub>	Turn-off energy			-	1.7	-
E <sub>ts</sub>	Total switching energy			-	4.2	-
t <sub>d(on)</sub>	Turn-on delay time	$T_j = 175$ °C; $V_{CC} = 600$ V; I <sub>C</sub> = 40 A; V <sub>GE</sub> = 15V / 0V; $R_G = 10$ Ω		-	54	-
t,	Rise time			-	46	-
$t_{\rm d(off)}$	Turn-off delay time			-	303	-
t <sub>f</sub>	Fall time			-	167	-
Eon	Turn-on energy			-	4	-
E <sub>off</sub>	Turn-off energy			-	2.5	-
E <sub>ts</sub>	Total switching energy			-	6.5	-
Diode cha	aracteristics	-				<u> </u>
t <sub>rr</sub>	Reverse recovery time	T <sub>j</sub> = 25 °C;		-	200	-
Q <sub>r</sub>	Reverse recovery charge	$V_{R} = 600 \text{ V}; \text{ I}_{F} = 40 \text{ A}; \text{ dI}_{F}/\text{dt} = 500 \text{ A}/\text{us}$		-	1660	-
I <sub>RM</sub>	Reverse recovery peak current			-	16	-
t <sub>rr</sub>	Reverse recovery time	T <sub>j</sub> = 175 °C;		-	453	-
Q <sub>r</sub>	Reverse recovery charge	$V_{R} = 600 \text{ V}; I_{F} = 40 \text{ A}; dI_{F}/dt = 500 \text{ A/us}$		-	5566	-

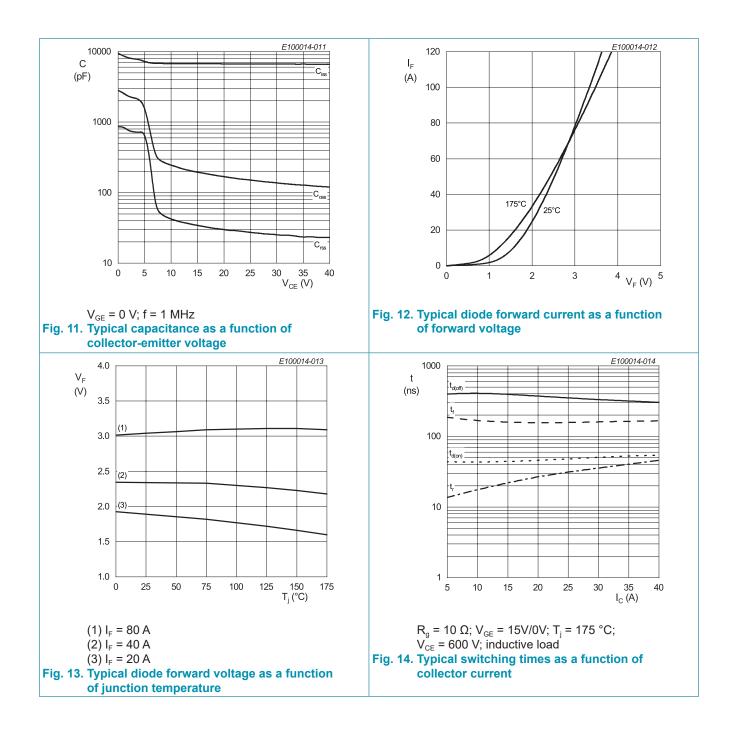
 $I_{RM}$ 

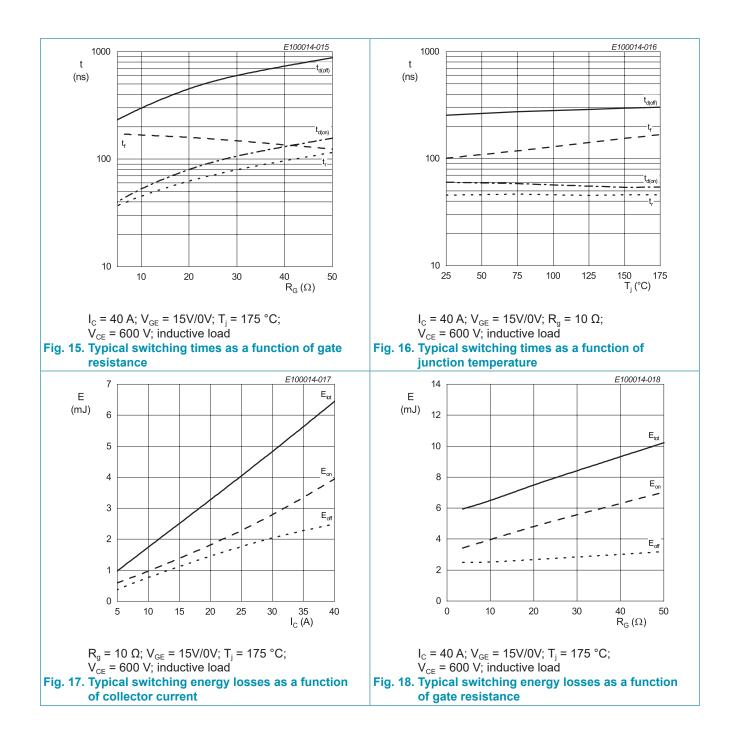
### WeEn Semiconductors

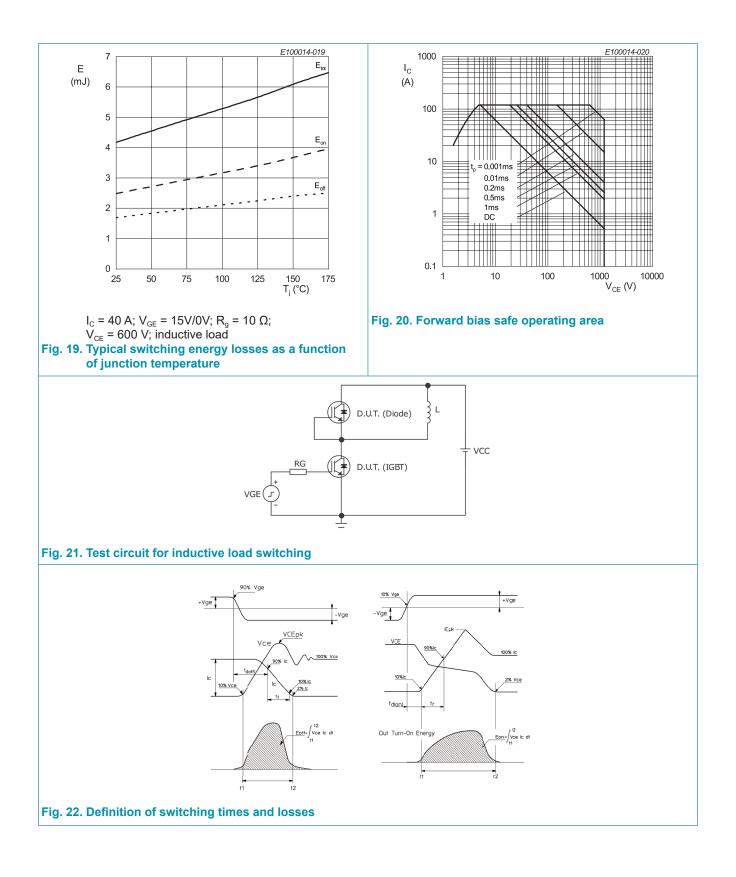
WG40N120MFW1

E100014-003 E100014-004 800 140  $\mathsf{P}_{\mathrm{tot}}$  $I_{\rm C}$ (W) 700 (A) 120 600 100 500 80 400 60 300 40 200 20 100 0 0 150 T<sub>c</sub> (°C) 75 175 25 50 100 125 25 50 75 100 125 150 175 T<sub>c</sub> (°C)  $V_{GE} \ge 15 \text{ V}; \text{ T}_{j} \le 175 \text{ °C}$ Fig. 4. Collector current as a function of case T<sub>i</sub> ≤ 175 °C Fig. 3. Power dissipation as a function of case temperature temperature E100014-005 E100014-006 120 120 V<sub>GE</sub>=20V V<sub>GE</sub>=20V  $I_{\rm C}$  $I_{\rm C}$ 17V 17V (A) 105 (A) 105 15V 15V 13V 11V 9V 13V 11V 90 90 9V 7V 7V 75 75 60 60 45 45 30 30 15 15 0 0 0 1 2 3 4 5 6 0 1 2 3 4 5 6  $V_{CE}$  (V)  $V_{CE}^{-}(V)$ T<sub>i</sub> = 25 °C T<sub>i</sub> = 175 °C Fig. 5. Typical output characteristic Fig. 6. Typical output characteristic

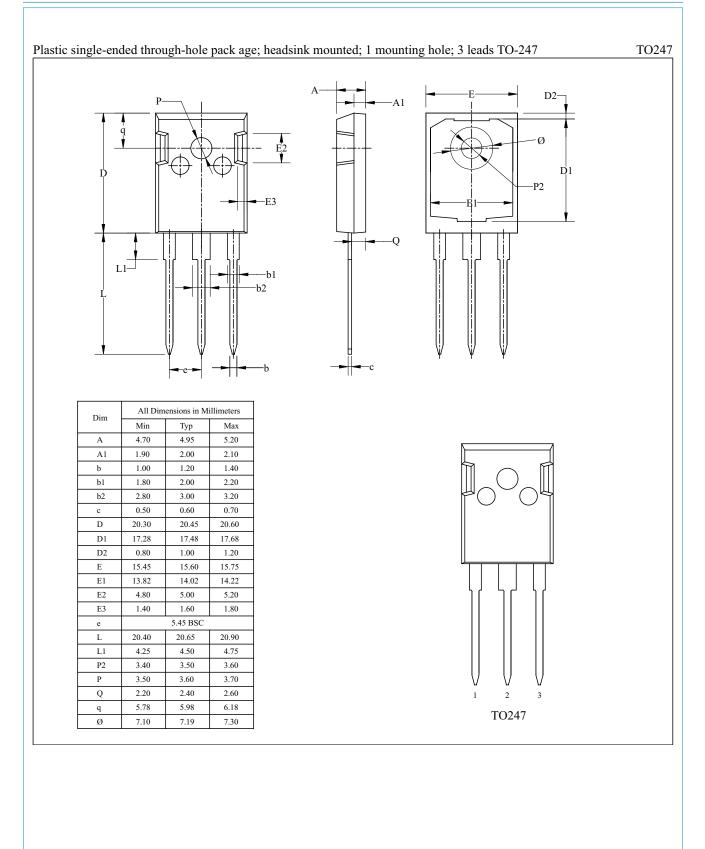








### 12. Package outline



# WG40N120MFW1

### 13. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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